

SNS COLLEGE OF TECHNOLOGY

Coimbatore-35 An Autonomous Institution



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DEPARTMENT OF ELECTRONICS & COMMUNICATION ENGINEERING

19ECB302–VLSI DESIGN

III YEAR/ V SEMESTER

UNIT 1 - MOS TRANSISTOR PRINCIPLE

TOPIC 7 – CV CHARACTERISTICS



MOS C-V CHARACTERISTICS



The measured MOS capacitance (called gate capacitance) varies with the applied gate voltage

- A very powerful diagnostic tool for identifying any deviations from the ideal in both oxide and semiconductor
- Routinely monitored during MOS device fabrication

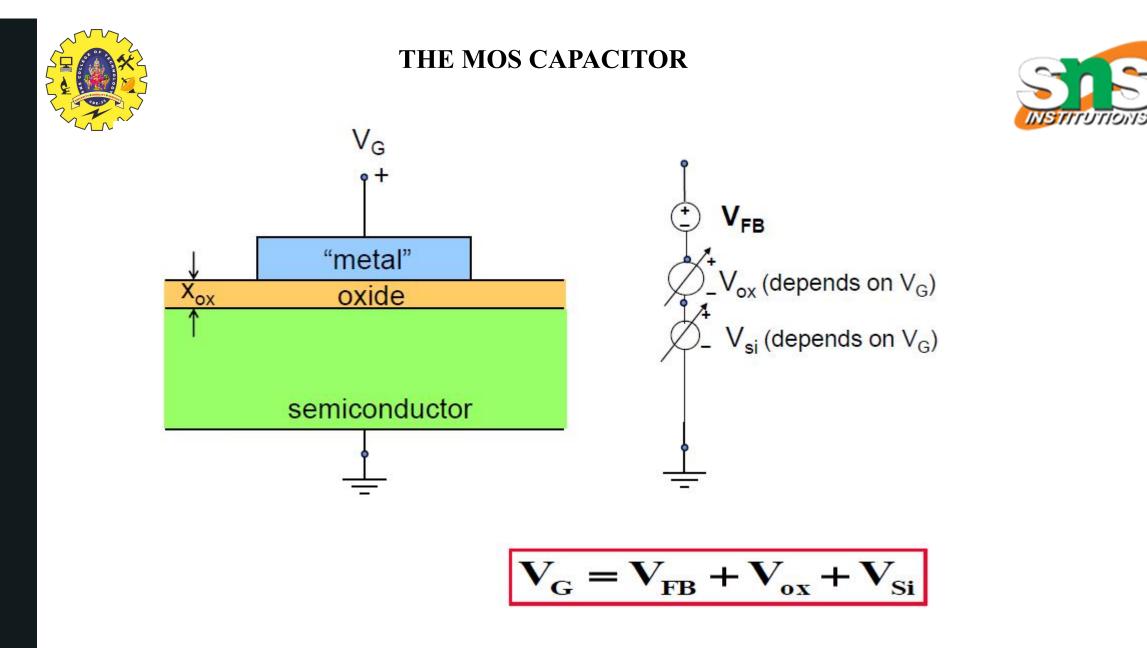


MEASUREMENT OF C-V CHARACTERISTICS



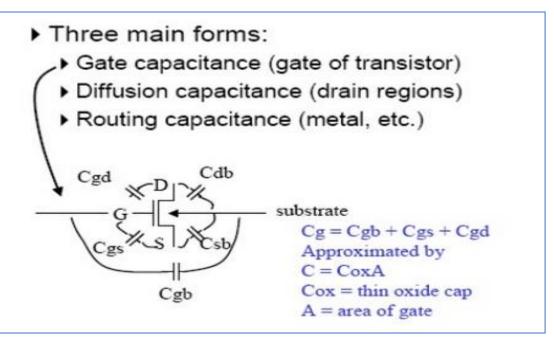
✤ Measurement of C-V characteristics

- Apply any dc bias, and superimpose a small ac signal
- Generally measured at 1 MHz (high frequency) or at variable frequencies between 1KHz to 1 MHz
- The dc bias *V*G is slowly varied to get **quasi-continuous** C-V characteristics





THE MOS CAPACITOR



VFB: Flat Band Voltage (depends on

semiconductor work function)

Vox = voltage drop across oxide (depends on VG)

VSi = voltage drop in the silicon (depends on VG)

$$\mathbf{V}_{\mathbf{G}} = \mathbf{V}_{\mathbf{FB}} + \mathbf{V}_{\mathbf{ox}} + \mathbf{V}_{\mathbf{Si}}$$





CAPACITANCE OF MOS DEVICE IN ACCUMALATION



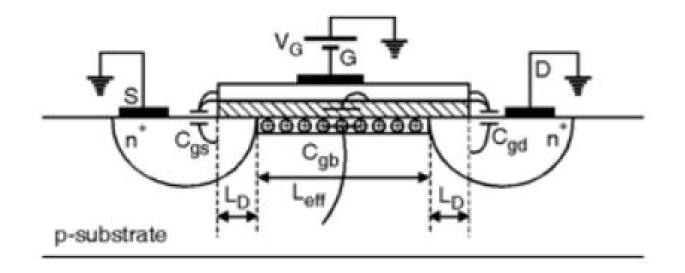
- The small signal capacitance is defined as $C = \frac{dQ}{dV}$
- First, consider a MOS device in accumulation
- · Under sufficiently high voltage, accumulation layer thickness is very small.
- The separation between the metal and semiconductor charge approaches the oxide thickness.
- · Consequently the capacitance approaches the oxide capacitance,

 $C = C_{ox} = \epsilon_{ox} / x_{ox}$: accumulation



CAPACITANCE OF MOS DEVICE IN ACCUMALATION





There are three types of capacitances are involved that are 1.Capacitance between gate electrode and substrate (C_{gb}), 2.Capacitance between gate and drain terminals (C_{gd}) 3. Capacitance between gate and source terminals (C_{gs})



CAPACITANCE OF MOS DEVICE IN DEPLETION



- At flat band voltage, V_G = V_{FB}, the accumulation layer disappears
 - and the capacitance decreases.
- As V_G is increased beyond V_{FB}, MOS is biased into depletion.
 - The semiconductor surface region is depleted and
 - the total capacitance is composed of the oxide capacitance and the depletion layer capacitance.

$$C = \left(\frac{1}{C_{ax}} + \frac{1}{C_s}\right)^{-1}$$



CAPACITANCE OF MOS DEVICE IN INVERSION



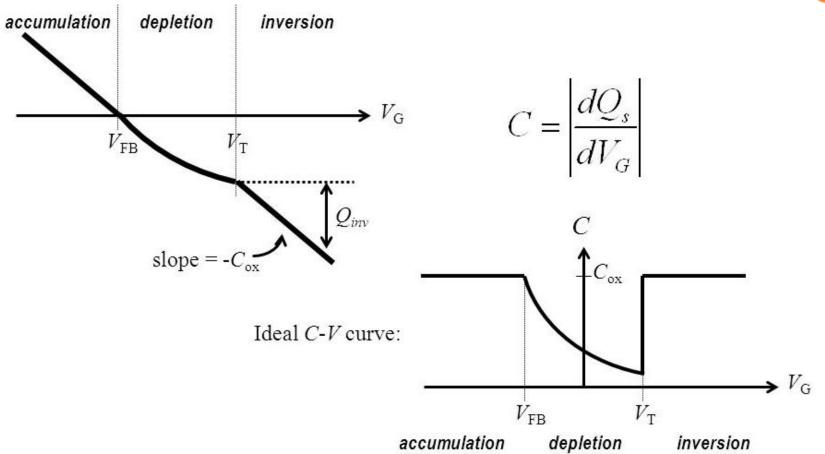
- Inversion layer charge responds to the measuring voltage.
- Since inversion layer is very thin in strong inversion,

$$C = C_{ox} = \frac{\mathcal{E}_{ox}}{x_{ox}}$$



CV CHARACTERISTICS

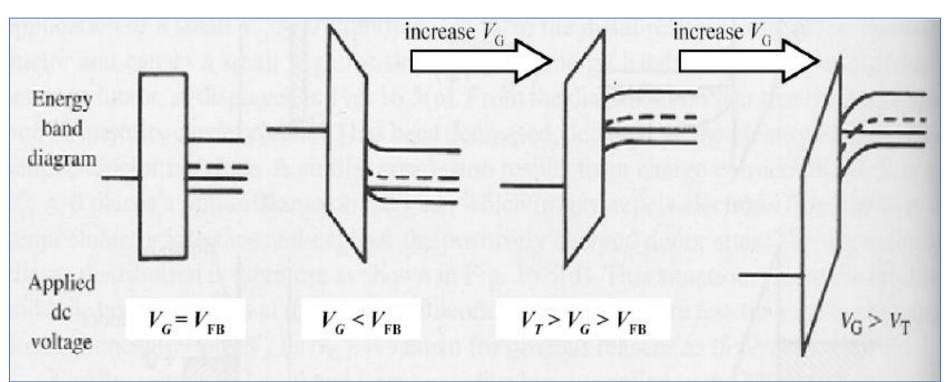






ENERGY BAND DIAGRAM

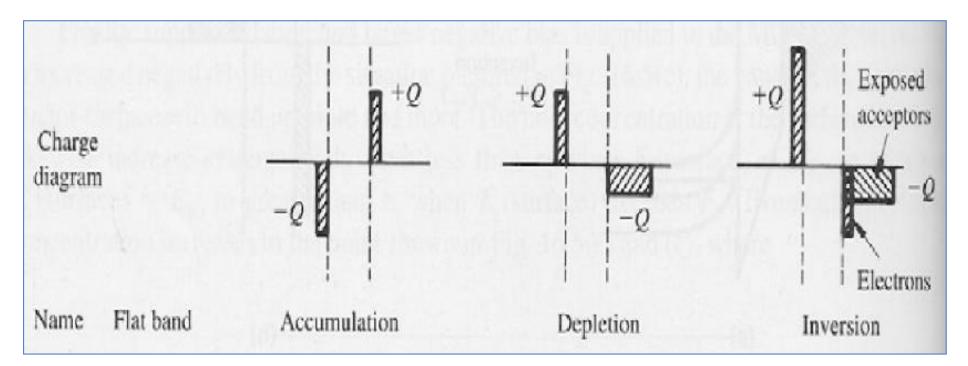






CHARGE DIAGRAM

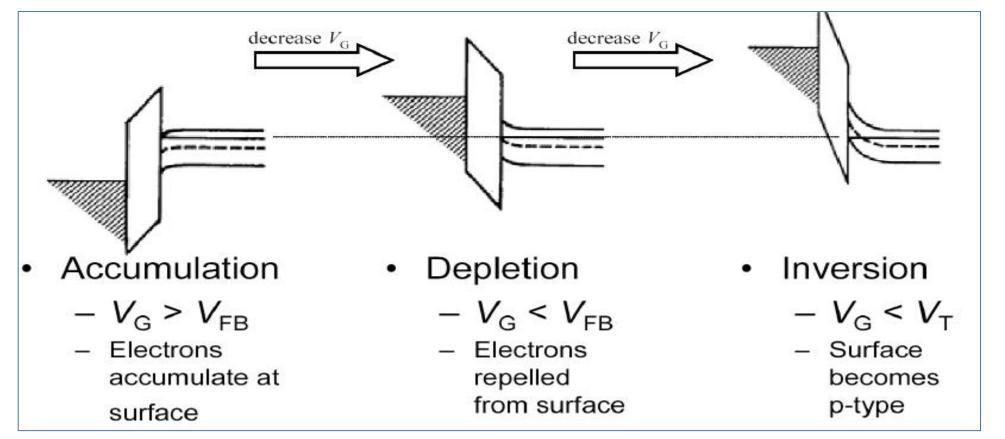






MOS BAND DIAGRAM







ASSESSMENT



- 1. Mode of operation
- 2. Region of operation
- 3. Capacitance in MOSFET





THNAK YOU